



Analog High Speed Optocoupler 100KBd, Photodiode with Darlington Output



#### Description

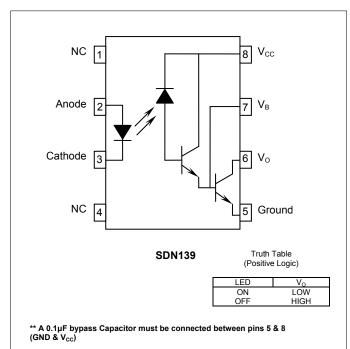
The SDN139 consists of a highly efficient AlGaAs Light Emitting Diode and an integrated high gain photo detector to provide extremely high current transfer ratio between input and output. Separate pins for the photodiode and output stage result in TTL compatible saturation voltage and high speed operation. Where desired the  $V_{CC}$  and  $V_0$  terminals may be tied together to achieve conventional photo Darlington operation. A base access terminal allows a gain bandwidth adjustment to be made.

The SDN139 comes standard in an 8 pin DIP package.

#### Applications

- Digital Logic Ground Isolation
- Replace Slower Speed Optocouplers
- Low Input Current Line Receivers
- Ring Detector Circuitry
- Loop Current Receiver
- High Common Mode Noise Line Receiver

### Schematic Diagram



#### Features

- TTL Compatible
- Low Control Current Requirements (0.5mA)
- High Output Current (60mA)
- High CTR Performance (2000%)
- High Isolation Voltage (5000V<sub>RMS</sub>)
- Instantaneous Common Mode Rejection (10kV/µS)
- RoHS / Pb-Free / REACH Compliant

#### Agency Approvals

UL / C-UL:	File # E201932
VDE:	File # 40035191 (EN 60747-5-2)

#### **Absolute Maximum Ratings**

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

Storage Temperature	55 to +125°C
Operating Temperature	40 to +85°C
Continuous Input Current	40mA
Transient Input Current	400mA
Reverse Input Control Voltage	5V
Max Input Current (I <sub>F</sub> )	40mA
Input Power Dissipation	40mW
Supply Voltage, Output Voltage (V <sub>CC</sub> , V <sub>O</sub> )	0.5 to 7V
Average Output Current (I <sub>0</sub> )	50mA
Emitter-Base Reverse Voltage (VER)	0.5V
Output Power Dissipation	100mW

### **Ordering Information**

Part Number	Description
Part Number	Description

SDN139	8 pin DIP, (50/Tube)
SDN139-H	0.40" (10.16mm) Lead Spacing (VDE0884)
SDN139-S	8 pin SMD, (50/Tube)
SDN139-STR	8 pin SMD, Tape and Reel (1000/Reel)

NOTE: Suffixes listed above are not included in marking on device for part number identification



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#### Electrical Characteristics, T<sub>A</sub> = 25°C (unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Input Specifications						
Input Forward Voltage	VF	-	1.1	1.7	V	I <sub>F</sub> = 1.6mA
Input Forward Voltage Temp Coefficient	$\Delta V_F / \Delta T$	-	-1.9	-	mV/°C	I <sub>F</sub> = 1.6mA
Input Reverse Voltage	BV <sub>R</sub>	5	-	-	V	I <sub>R</sub> = 10μA
Input Capacitance	CIN	-	60	-	pF	f=1MHz, V <sub>F</sub> =0V
Output Specifications						
Current Transfer Ratio	CTR	400	2000	5000	%	I <sub>F</sub> =0.5mA, V <sub>O</sub> =0.4V, V <sub>CC</sub> =4.5V
	UIK	500	1600	2600	%	I <sub>F</sub> =1.6mA, V <sub>O</sub> =0.4V, V <sub>CC</sub> =4.5V
		-	0.1	0.4	V	I <sub>F</sub> =0.5mA, V <sub>CC</sub> =4.5V, I <sub>O</sub> =2mA
Logic LOW Output Voltage	V <sub>OL</sub>	-	0.1	0.4	V	$I_F$ =1.6mA, $V_{CC}$ =4.5V, $I_O$ =8mA
Logic LOW Output Voltage	V OL	-	0.1	0.4	V	$I_F$ =5mA, $V_{CC}$ =4.5V, $I_O$ =15mA
		-	0.2	0.4	V	I <sub>F</sub> =12mA, V <sub>CC</sub> =4.5V, I <sub>0</sub> =24mA
Logic HIGH Output Current	I <sub>ОН</sub>	-	0.1	100	μA	I <sub>F</sub> =0mA, V <sub>CC</sub> =18V, V <sub>O</sub> =18V
Logic LOW Supply Current	I <sub>CCL</sub>	-	0.4	1.5	mA	I <sub>F</sub> =1.6mA, V <sub>O</sub> =Open, V <sub>CC</sub> =18V
Logic HIGH Supply Current	I <sub>CCH</sub>	-	0.01	10	mA	$V_{E}$ =0.5V, $V_{CC}$ =5.5V, $I_{F}$ =0mA
Switching Specifications, V <sub>CC</sub> = 5V (unless	otherwise specifi	ed)				
Propagation Delay Time to		-	5	25	μS	I <sub>F</sub> =0.5mA, R <sub>L</sub> =4.7kΩ
Low Output Level	t <sub>PHL</sub>	-	0.1	1	μS	$I_F$ =12mA, R <sub>L</sub> =270 $\Omega$
Propagation Delay Time to		-	18	60	μS	$I_F=0.5mA$ , $R_L=4.7k\Omega$
High Output Level	t <sub>PLH</sub>	-	2	7	μS	I <sub>F</sub> =12mA, R <sub>L</sub> =270Ω
Logic HIGH Common Mode Transient Immunity	CM <sub>H</sub>	1	10	-	V/µS	$I_{F}$ =0mA, $ V_{CM} $ =10 $V_{P-P}$ , $R_{L}$ =2.2k $\Omega$
Logic LOW Common Mode Transient Immunity	CM∟	1	10	-	V/µS	$I_{\text{F}}\text{=}1.6\text{mA},  V_{\text{CM}} \text{=}10V_{\text{P}\text{-P}}, \text{R}_{\text{L}}\text{=}2.2\text{k}\Omega$
Isolation Specifications						
Input-Output Insulation Leakage Current	I <sub>I-O</sub>	-	-	1.0	μA	45% RH, t=5s, V <sub>I-0</sub> =3kV
Withstand Insulation Test Voltage	V <sub>ISO</sub>	5000	-	-	V <sub>RMS</sub>	RH ≤ 50%, t=1min
Input-Output Resistance	R <sub>I-0</sub>	-	10 <sup>12</sup>	-	Ω	V <sub>I-0</sub> = 500V <sub>DC</sub>
Input-Output Capacitance	CI-O	-	1.0	-	pF	f=1MHz



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### **SDN139 Electrical Test Circuits**

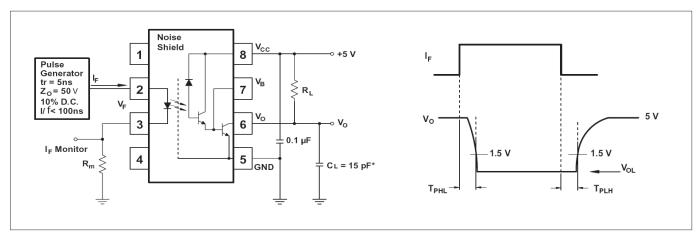


Figure 1: Single Channel Test Circuit for t<sub>PHL</sub> and t<sub>PLH</sub>

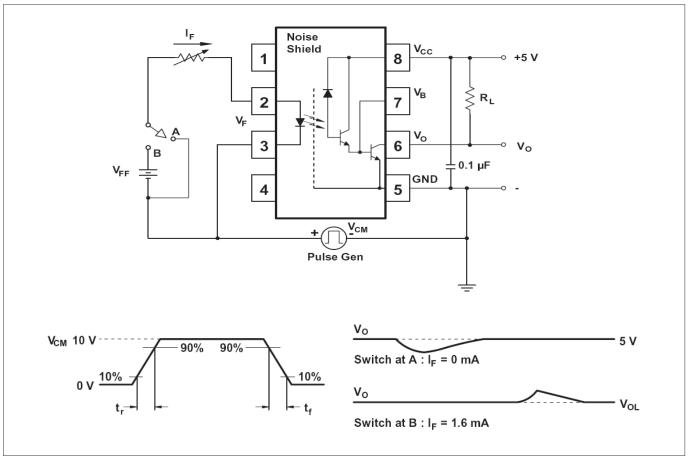
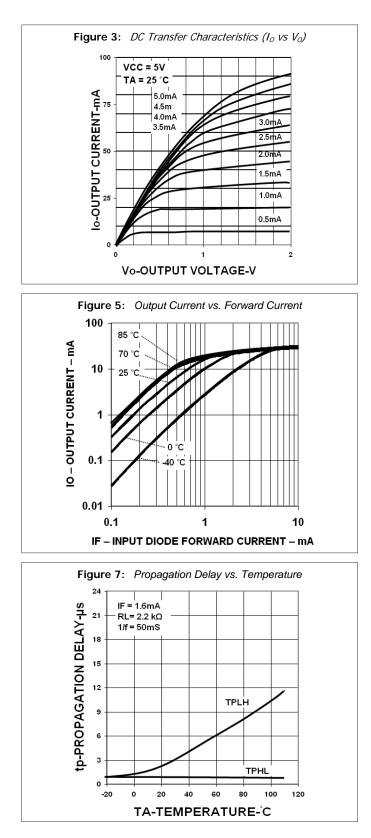


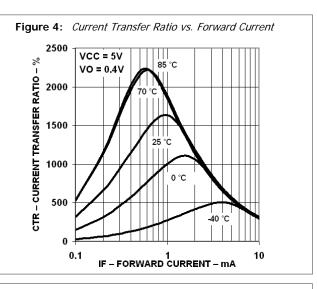
Figure 2: Single Channel Test Circuit for t<sub>EHL</sub> and t<sub>ELH</sub>

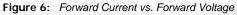


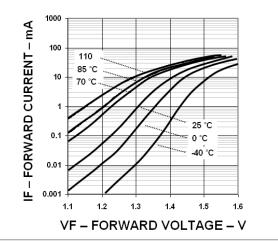
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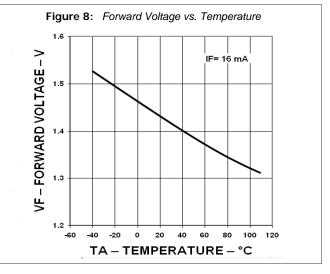
#### SDN139 Performance & Characteristics Plots, T<sub>A</sub> = 25°C (unless otherwise specified)





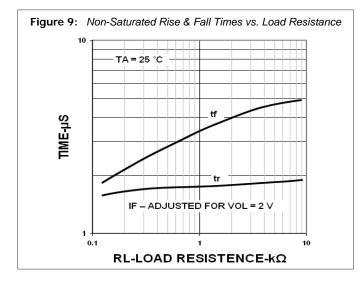




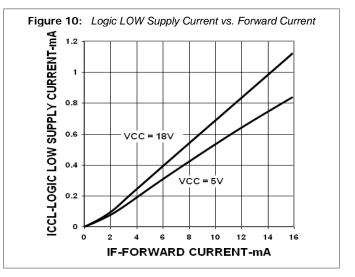


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#### SDN139 Solder Reflow Temperature Profile Recommendations

#### (1) Infrared Reflow:

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250°C:

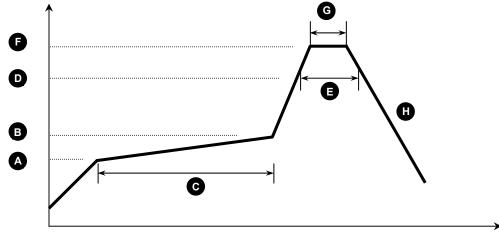


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Process Step	Description	Parameter	
Α	Preheat Start Temperature (°C)	150°C	
В	Preheat Finish Temperature (°C)	180°C	
С	Preheat Time (s)	90 - 120s	
D	Melting Temperature (°C)	230°C	
E	Time above Melting Temperature (s)	30s	
F	Peak Temperature, at Terminal (°C)	260°C	
G	Dwell Time at Peak Temperature (s)	10s	
Н	Cool-down (°C/s)	<6°C/s	

#### (2) Wave Solder:

Maximum Temperature:	260°C (at terminal)
Maximum Time:	10s
Pre-heating:	100 - 150°C (30 - 90s)
Single Occurrence	

(3) Hand Solder:

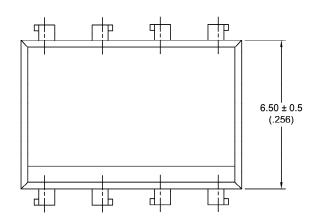
Maximum Temperature:	350°C	(at tip of soldering iron)
Maximum Time:	3s	
Single Occurrence		

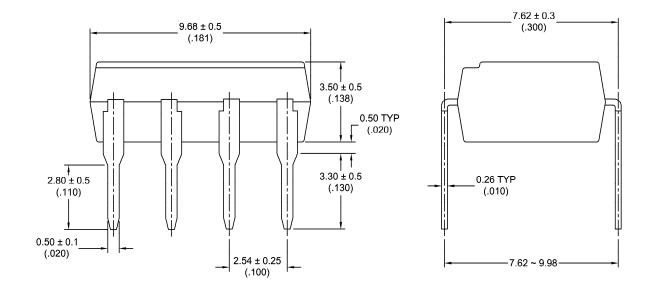


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#### SDN139 Package Dimensions

8 PIN DIP Package



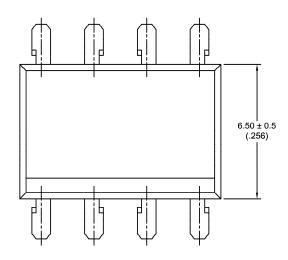


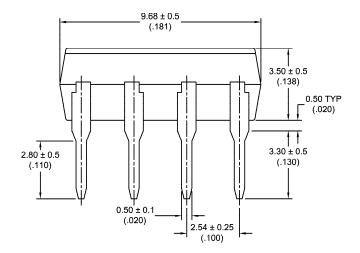


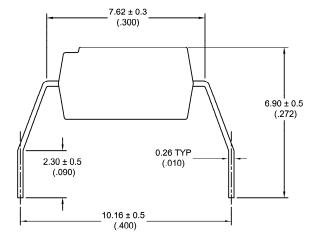
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#### SDN139 Package Dimensions

8 PIN WIDE Lead Space Package (-H)





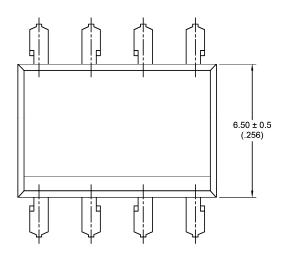


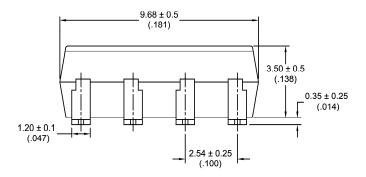


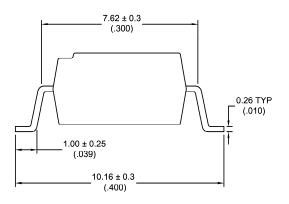
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#### SDN139 Package Dimensions

8 PIN SMD Surface Mount Package (-S)





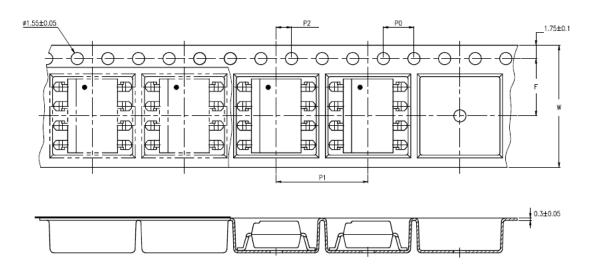




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### **SDN139 Packaging Specifications**

### Tape & Reel Specifications (T&R)



Specification	Symbol	Dimensions, mm ( inches )
Tape Width	W	$16 \pm 0.3$ ( $0.63$ )
Sprocket Hole Pitch	P0	4 ± 0.1 ( 0.15 )
Compartment Location	F P2	$\begin{array}{c} 7.5\pm 0.1 \;(\; 0.295\;) \\ 2\pm 0.1 \;(\; 0.079\;) \end{array}$
Compartment Pitch	P1	12 ± 0.1 ( 0.472 )



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